

WDS[®] Nextra Board

Product Data Sheet



Product Description

WDS Nextra Board is a rigid and compact microporous insulation with an engineered mineral matrix designed for applications where the lowest thermal conductivity up to 1000°C (1832°F) is the main selection criteria.

Like any other microporous insulation of our industrial range produced with our exclusive WDS Technology process, WDS Nextra Board features extremely good handling and machining properties; the extremely low thermal conductivity coefficient provides very good insulating properties with reduced thickness, allowing to design equipment where the highest energy efficiency, space optimization and reduction of weight are premium factors to be considered.

Features

- Best-in-class amongst other market solutions within the same classification temperature and similar chemistry, for the lowest thermal conductivity it provides in the entire temperature spectrum up to its classification temperature.
- Not affected by thermal shock
- Improved product mineral matrix core features minimal dust release and very good handling and machining abilities

Benefits

- Dimensionally stable over time up to the maximum using temperature
- Helps to control energy efficiency and heat flow very precisely
- Easy to cut and with proven installation techniques
- Freedom in engineering at the design stage
- Increases effective volume inner capacity or reduces encumbrance in equipment and apparels of any kind.
- Largest product dimensions available
- Environmentally friendly

Applications

- Metal production
- Petrochemical process units
- Energy storage
- Fuel Cells
- Glass making
- Ceramic kilns
- Cement kilns
- Power Generation
- Incineration

Environmental and Health Safety

WDS Nextra Board does not contain any hazardous or decomposition substance according to the EU Directive 2006/1907/EEC and IARC. The fibers or filaments used as reinforcement of the mineral core are also exonerated from any classification as defined by the WHO (World Health Organization) and EU Directive 97/69/EC.

Resistance to Moisture and Water

WDS Nextra Board has a porous surface therefore it is sensitive to all liquids that can wet it; this includes substances such as water, oil and petroleum spirit, since they can destroy the pore structure. Non condensed moisture does not affect the product.

Sensitivity to liquids of WDS Nextra Board can be eliminated by using a surface treatment such as temperature resistant aluminum foil or shrink-wrapped PE Film.

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1 of 2

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Properties	WDS Nextra Board	
Classification Temperature, °C (°F)	1000 (1832)	
Density, kg/m³ (pcf), nominal	275 (17.2)	
Cold Compression Strength, MPa (psi), ASTM C 165	>0.3 (43.5)	
Linear Shrinkage, %, ASTM C 365		
Full soak, 1000°C (1832°F), 24 hours	<3.0	
Chemical Analysis, %		
Silica, SiO ₂	55-75	
Silicon Carbide, SiC	25-40	
Others	3-10	
Loss of Ignition, Dry condition	<2.5	
Thermal Conductivity, W/m•K (BTU•in/hr•ft²•°F), ASTM C 177		
200°C (392°F)	0.022 (0.153)	
400°C (752°F)	0.023 (0.160)	
600°C (1112°F)	0.027 (0.187)	
800°C (1472°F)	0.033 (0.229)	

Shelf Life

- · WDS Nextra Board has unlimited shelf life if it stored properly
- WDS Nextra Board must be handled and stored in dry conditions
- WDS Nextra Board is resistant to diffusion by atmospheric humidity (water vapor) proving condensation is avoided

Standard Dimensions and Availability

Dimensions, mm (in)	Thickness, mm (in)
1000 x 650 (39.3 x 24.41)	10, 12, 15, 17, 20, 25, 30, 35, 40, 45, 50
1320 x 1000 (47.24 x 39.27)	(0.4, 0.5, 0.6, 0.7, 0.8, 1, 1.18, 1.37, 1.57, 1.77, 2)

Whilst the values and application information in this datasheet are typical, they are given for guidance only. The values and the information given are subject to normal manufacturing variation and may be subject to change without notice. Morgan Advanced Materials – Thermal Ceramics makes no guarantees and gives no warranties about the suitability of a product and you should seek advice to confirm the product's suitability for use with Morgan Advanced Materials - Thermal Ceramics.

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Code: MP.10 2 of 2